

Data sheet acquired from Harris Semiconductor SCHS243A

October 1998 - Revised May 2000

Presettable Synchronous 4-Bit Binary Up/Down Counter

Features

- Buffered Inputs
- Typical Propagation Delay
 - 12.8ns at $V_{CC} = 5V$, $T_A = 25^{\circ}C$, $C_L = 50pF$
- Exceeds 2kV ESD Protection MIL-STD-883, Method 3015
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Speed of Bipolar FAST™/AS/S with Significantly Reduced Power Consumption
- Balanced Propagation Delays
- AC Types Feature 1.5V to 5.5V Operation and Balanced Noise Immunity at 30% of the Supply
- ±24mA Output Drive Current
 - Fanout to 15 FAST™ ICs
 - Drives 50Ω Transmission Lines

Ordering Information

PART NUMBER	TEMP. RANGE (^O C)	PACKAGE
CD54AC191F3A	-55 to 125	16 Ld CERDIP
CD54ACT191F3A	-55 to 125	16 Ld CERDIP

NOTES:

- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer and die for this part number is available which meets all electrical specifications. Please contact your local TI sales office or customer service for ordering information.

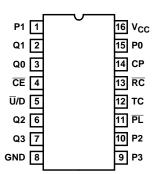
Description

The CD54AC191 and CD54ACT191 are asynchronously presettable binary up/down synchronous counters that utilize Advanced CMOS Logic technology. Presetting the counter to the number on preset data inputs (P0-P3) is accomplished by setting LOW the asynchronous parallel load input (\overline{PL}) . Counting occurs when PL is HIGH, Count Enable (\overline{CE}) is LOW, and the Up/Down (\overline{U}/D) input is either LOW for upcounting or HIGH for down-counting. The counter is incremented or decremented synchronously with the LOW-to-HIGH transition of the clock.

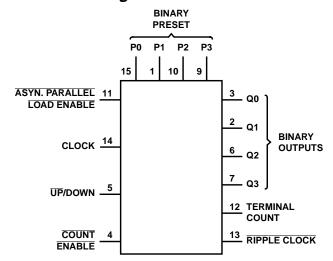
When an overflow or underflow of the counter occurs, the Terminal Count (TC) output, which is LOW during counting, goes HIGH and remains HIGH for one clock cycle. This output can be used for look-ahead carry in high-speed cascading (see Figure 12). The TC output also initiates the Ripple Clock (\overline{RC}) output which, normally HIGH, goes LOW and remains LOW for the low-level cascaded using the Ripple Count output.

Pinout

CD54AC191, CD54ACT191 (CERDIP) TOP VIEW



Functional Diagram



TRUTH TABLE

	INF			
PL	CE	Ū/D	СР	FUNCTION
Н	L	L	1	Count Up
Н	L	Н	1	Count Down
L	Х	Х	Х	Asynchronous Preset
Н	Н	Х	Х	No Change

 $\overline{\mbox{U}}/\mbox{D}$ or $\overline{\mbox{CE}}$ should be changed only when clock is high.

X = Don't Care

 \uparrow = Low-to-High clock transition.

Absolute Maximum Ratings

DC Supply Voltage, V _{CC} 0.5V to 6V
DC Input Diode Current, I _{IK}
For $V_1 < -0.5V$ or $V_1 > V_{CC} + 0.5V$
DC Output Diode Current, I _{OK}
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$
DC Output Source or Sink Current per Output Pin, IO
For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$
DC V_{CC} or Ground Current, I_{CC} or I_{GND} (Note 3) $\pm 100 mA$

Thermal Information

Thermal Resistance (Typical, Note 5)	θ_{JA} ($^{o}C/W$)
PDIP Package	
SOIC Package	
Maximum Junction Temperature (Hermetic Package or I	Die) 175 ⁰ C
Maximum Storage Temperature Range	65 ⁰ C to 150 ⁰ C
Maximum Lead Temperature (Soldering 10s)	300 ^o C

Operating Conditions

Temperature Range, T _A 55°C to 125°C
Supply Voltage Range, V _{CC} (Note 4)
AC Types
ACT Types
DC Input or Output Voltage, V _I , V _O 0V to V _{CC}
Input Rise and Fall Slew Rate, dt/dv
AC Types, 1.5V to 3V 50ns (Max)
AC Types, 3.6V to 5.5V
ACT Types, 4.5V to 5.5V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTES:

- 3. For up to 4 outputs per device, add $\pm 25 \text{mA}$ for each additional output.
- 4. Unless otherwise specified, all voltages are referenced to ground.
- 5. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

		TEST CONDITIONS		v _{cc}	25	°C		C TO °C		C TO 5°C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
AC TYPES											
High Level Input Voltage	V _{IH}	-	-	1.5	1.2	-	1.2	-	1.2	-	V
				3	2.1	-	2.1	-	2.1	-	V
				5.5	3.85	-	3.85	-	3.85	-	V
Low Level Input Voltage	V _{IL}	-	-	1.5	-	0.3	-	0.3	-	0.3	V
				3	-	0.9	-	0.9	-	0.9	V
				5.5	-	1.65	-	1.65	-	1.65	V
High Level Output Voltage	Voн	V _{IH} or V _{IL}	-0.05	1.5	1.4	-	1.4	-	1.4	-	V
			-0.05	3	2.9	-	2.9	-	2.9	-	V
			-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-4	3	2.58	-	2.48	-	2.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	-	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V

DC Electrical Specifications (Continued)

			ST ITIONS	v _{cc}	25	o°C		C TO °C		C TO 5°C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(v)	MIN	MAX	MIN	MAX	MIN	MAX	UNITS
Low Level Output Voltage	V_{OL}	V _{IH} or V _{IL}	0.05	1.5	-	0.1	-	0.1	-	0.1	V
			0.05	3	-	0.1	-	0.1	-	0.1	V
			0.05	4.5	-	0.1	-	0.1	-	0.1	V
			12	3	-	0.36	-	0.44	-	0.5	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	IJ	V _{CC} or GND	-	5.5	-	±0.1	-	±1	-	±1	μΑ
Quiescent Supply Current MSI	I _{CC}	V _{CC} or GND	0	5.5	-	8	-	80	-	160	μΑ
ACT TYPES											
High Level Input Voltage	V _{IH}	-	-	4.5 to 5.5	2	-	2	-	2	-	V
Low Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage	V _{OH}	V _{IH} or V _{IL}	-0.05	4.5	4.4	-	4.4	-	4.4	-	V
			-24	4.5	3.94	-	3.8	-	3.7	-	V
			-75 (Note 6, 7)	5.5	ı	-	3.85	-	-	-	V
			-50 (Note 6, 7)	5.5	-	-	-	-	3.85	-	V
Low Level Output Voltage	V _{OL}	V _{IH} or V _{IL}	0.05	4.5	-	0.1	-	0.1	-	0.1	V
			24	4.5	-	0.36	-	0.44	-	0.5	V
			75 (Note 6, 7)	5.5	-	-	-	1.65	-	-	V
			50 (Note 6, 7)	5.5	-	-	-	-	-	1.65	V
Input Leakage Current	IJ	V _{CC} or GND	-	5.5	-	±0.1	-	±1	-	±1	μΑ
Quiescent Supply Current MSI	I _{CC}	V _{CC} or GND	0	5.5	-	8	-	80	-	160	μΑ
Additional Supply Current per Input Pin TTL Inputs High 1 Unit Load	Δl _{CC}	V _{CC} -2.1	-	4.5 to 5.5	-	2.4	-	2.8	-	3	mA

NOTES:

- 6. Test one output at a time for a 1-second maximum duration. Measurement is made by forcing current and measuring voltage to minimize power dissipation.
- 7. Test verifies a minimum 50Ω transmission-line-drive capability at $85^{o}C$, 75Ω at $125^{o}C$.

ACT Input Load Table

INPUT	UNIT LOAD
P0-P3, PL	0.75
CL, U/D, CE	0.85

NOTE: Unit load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g., 2.4mA max at 25°C.

Prerequisite For Switching Function

			-40°C	ГО 85 ⁰ С	-55°C T		
PARAMETER	SYMBOL	V _{CC} (V)	MIN	MAX	MIN	MAX	UNITS
AC TYPES							
Max. Frequency	f _{MAX}	1.5	5.5	-	4.8	-	MHz
	(Note 10)	3.3 (Note 8)	49	-	43	-	MHz
		5 (Note 9)	68	-	60	-	MHz
CP Pulse Width	t _W	1.5	91	-	104	-	ns
		3.3	10.5	-	11.6	-	ns
		5	7.3	-	8.3	-	ns
PL Pulse Width	t _W	1.5	66	-	75	-	ns
		3.3	7.4	-	8.4	-	ns
		5	5.3	-	6	-	ns
Recovery Time	t _{REC}	1.5	71	-	81	-	ns
		3.3	8	-	9.1	-	ns
		5	5.7	-	6.5	-	ns
Set-Up Time, Pn to PL	t _{SU}	1.5	44	-	50	-	ns
		3.3	4.9	-	5.6	-	ns
		5	3.5	-	4	-	ns
Set-Up Time, CE to CP	t _{SU}	1.5	115	-	131	-	ns
		3.3	12.9	-	14.7	-	ns
		5	9.2	-	10.5	-	ns
Set-Up Time, $\overline{\text{U}}/\text{D}$ to CP	t _{SU}	1.5	132	-	150	-	ns
		3.3	14.7	-	16.8	-	ns
		5	10.5	-	12	-	ns
Hold Time, Pn to PL	t _H	1.5	22	-	25	-	ns
		3.3	2.5	-	2.8	-	ns
		5	2	-	2	-	ns
Hold Time, CE to CP	t _H	1.5	0	-	0	-	ns
		3.3	0	-	0	-	ns
		5	0	-	0	-	ns
Hold Time, U/D to CP	tH	1.5	0	-	0	-	ns
		3.3	0	-	0	-	ns
		5	0	-	0	-	ns
ACT TYPES		-					1
Max. Frequency	f _{MAX} (Note 10)	5 (Note 9)	68	-	60	-	MHz
CP Pulse Width	t _W	5	7.3	-	8.3	-	ns
PL Pulse Width	t _W	5	5.3	-	6	-	ns
Recovery Time	t _{REC}	5	5.7	-	6.5	-	ns
Set-Up Time, Pn to PL	t _{SU}	5	3.5	-	4	-	ns

Prerequisite For Switching Function (Continued)

			-40°C TO 85°C		-55°C T		
PARAMETER	SYMBOL	V _{CC} (V)	MIN	MAX	MIN	MAX	UNITS
Set-Up Time, CE to CP	tsu	5	9.2	-	10.5	-	ns
Set-Up Time, U/D to CP	tsu	5	10.5	-	12	-	ns
Hold Time, Pn to PL	t _H	5	2	-	2	-	ns
Hold Time, CE to CP	t _H	5	0	-	0	-	ns
Hold Time, U/D to CP	t _H	5	0	-	0	-	ns

NOTES:

- 8. 3.3V Min is at 3V.
- 9. 5V Min is at 4.5V.
- 10. Applies to non-cascaded operation only. With cascaded counters clock-to-terminal count propagation delays, count enable (CE)-to-clock set-up times, and count enable (CE)-to-clock hold times determine max clock frequency. For example, with these AC devices at 85°C and V_{CC} = 5V:.

$$f_{MAX} (CP) = \frac{1}{CP-to-TC \text{ prop. delay} + \overline{CE}-to-CP \text{ setup} + \overline{CE}-to-CP \text{ Hold}} = \frac{1}{18.2 + 9.2 + 0} \approx 36 \text{MHz}$$

Switching Specifications Input t_r , $t_f = 3ns$, $C_L = 50pF$ (Worst Case)

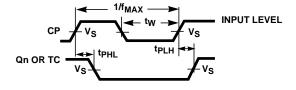
			-40 ⁰	C TO 85°	С	-55	°C TO 12	5°C	
PARAMETER	SYMBOL	V _{CC} (V)	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
AC TYPES	·	•			•			•	
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	171	-	-	188	ns
PL to Qn		3.3 (Note 12)	5.4	-	19.1	5.3	-	21	ns
		5 (Note 13)	3.9	-	13.6	3.8	-	15	ns
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	173	-	-	190	ns
Pn to Qn		3.3	5.4	-	19.4	5.3	-	21.3	ns
		5	3.9	-	13.8	3.8	-	15.2	ns
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	182	-	-	200	ns
CP to Qn		3.3	5.8	-	20.4	5.6	-	22.4	ns
		5	4.1	-	14.5	4	-	16	ns
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	136	-	-	150	ns
CP to RC		3.3	4.3	-	15.3	4.2	-	16.8	ns
		5	3.1	-	11	3	-	12	ns
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	227	-	-	250	ns
CP to TC		3.3	7.2	-	25.5	7	-	28	ns
		5	5.2	-	18.2	5	-	20	ns
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	246	-	-	271	ns
U/D to RC		3.3	7.8	-	27.6	7.6	-	30.4	ns
		5	5.6	-	19.7	5.4	-	21.7	ns
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	160	-	-	176	ns
Ū/D to TC		3.3	5.1	-	17.9	4.9	-	19.7	ns
		5	3.6	-	12.8	3.5	-	14.1	ns

Switching Specifications Input t_r , t_f = 3ns, C_L = 50pF (Worst Case) (Continued)

			-40°	C TO 85°	C	-55	OC TO 12	5°C	UNITS
PARAMETER	SYMBOL	V _{CC} (V)	MIN	TYP	MAX	MIN	TYP	MAX	
Propagation Delay	t _{PLH} , t _{PHL}	1.5	-	-	137	-	-	151	ns
CE to RC		3.3	4.4	-	15.4	4.2	-	16.9	ns
		5	3.1	-	11	3	-	12.1	ns
Input Capacitance	Cl	-	-	-	10	-	-	10	pF
Power Dissipation Capacitance	C _{PD} (Note 14)	-	-	96	-	-	96	-	pF
ACT TYPES		•		•			•	•	•
Propagation Delay PL to Qn	t _{PLH} , t _{PHL}	5 (Note 13)	4.2	-	14.8	4.1	-	16.3	ns
Propagation Delay Pn to Qn	t _{PLH} , t _{PHL}	5	3.9	-	13.8	3.8	-	15.2	ns
Propagation Delay CP to Qn	t _{PLH} , t _{PHL}	5	4.1	-	14.5	4	-	16	ns
Propagation Delay CP to RC	t _{PLH} , t _{PHL}	5	3.1	-	10.9	3	-	12	ns
Propagation Delay CP to TC	t _{PLH} , t _{PHL}	5	5.2	-	18.2	5	-	20	ns
Propagation Delay U/D to RC	t _{PLH} , t _{PHL}	5	5.6	-	19.7	5.4	-	21.7	ns
Propagation Delay U/D to TC	t _{PLH} , t _{PHL}	5	3.8	-	13.5	3.7	-	14.9	ns
Propagation Delay CE to RC	t _{PLH} , t _{PHL}	5	3.3	-	11.5	3.2	-	12.7	ns
Input Capacitance	Cl	-	-	-	10	-	-	10	pF
Power Dissipation Capacitance	C _{PD} (Note 14)	-	-	96	-	-	96	-	pF

NOTES:

- 11. Limits tested 100%.
- 12. 3.3V Min is at 3.6V, Max is at 3V.
- 13. 5V Min is at 5.5V, Max is at 4.5V
- 14. C_{PD} is used to determine the dynamic power consumption per package. $P_D = C_{PD} V_{CC}^2 f_i + (C_L + V_{CC} 2 f_0)$ where f_i = input frequency, f_0 = output frequency, C_L = output load capacitance, V_{CC} = supply voltage.



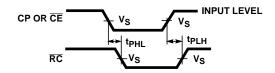


FIGURE 2.

FIGURE 1.

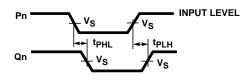


FIGURE 3.

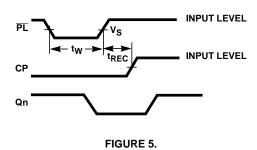
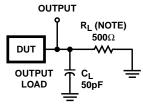


FIGURE 7.



NOTE: For AC Series Only: When V_{CC} = 1.5V, R_L = 1k Ω .

	AC	ACT
Input Level	V _{CC}	3V
Input Switching Voltage, V _S	0.5 V _{CC}	1.5V
Output Switching Voltage, V _S	0.5 V _{CC}	0.5 V _{CC}

FIGURE 9. PROPAGATION DELAY TIMES

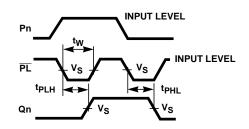
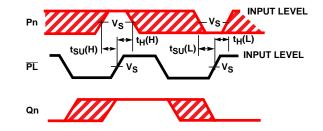


FIGURE 4.



The shaded areas indicate when the input is permitted to change for predictable output performance.

FIGURE 6.

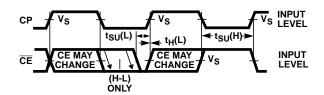
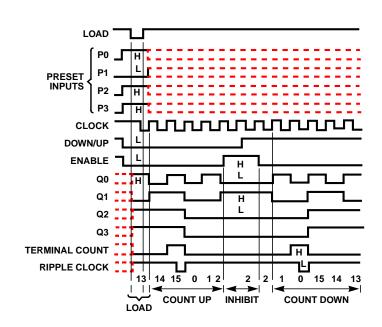


FIGURE 8.



Sequence:

- 1. Load (preset) to binary thirteen.
- 2. Count up to fourteen, fifteen, zero, one, and two.
- 3. Inhibit
- 4. Count down to one, zero, fifteen, fourteen, and thirteen.

FIGURE 10. CD54AC191 DECODE COUNTERS TYPICAL LOAD, COUNT, AND INHIBIT SEQUENCES

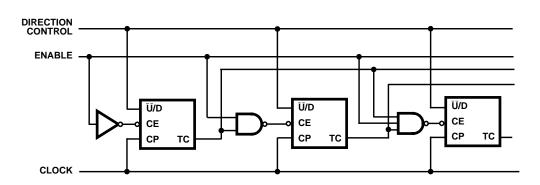


FIGURE 11. SYNCHRONOUS N-STAGE COUNTER WITH PARALLEL GATED TC/RC

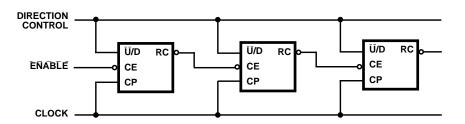


FIGURE 12. SYNCHRONOUS N-STAGE COUNTER USING RIPPLE TC/RC





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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD54AC191F3A	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI
CD54ACT191F3A	OBSOLETE	CDIP	J	16	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF CD54AC191, CD54ACT191:

Catalog: CD74AC191, CD74ACT191

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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